

H5N2514P

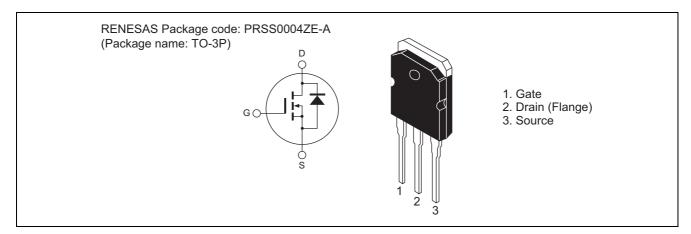
Silicon N Channel MOS FET High Speed Power Switching

REJ03G1203-0100 Rev.1.00 May 25.2005

Features

- Low on-resistance
- Low leakage current
- High speed switching

Outline



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to Source voltage	V _{DSS}	250	V
Gate to Source voltage	V _{GSS}	±30	V
Drain current	I _D	70	A
Drain peak current	I _{D (pulse)} Note1	210	Α
Body-Drain diode reverse Drain current	I _{DR}	70	Α
Body-Drain diode reverse Drain peak current	I _{DR (pulse)} Note1	210	Α
Avalanche current	I _{AP} Note3	35	A
Avalanche energy	E _{AR} Note3	76.5	mJ
Channel dissipation	Pch Note2	200	W
Channel to case thermal impedance	θch-c	0.625	°C/W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at Tc = 25°C

3. STch = 25° C, Tch $\leq 150^{\circ}$ C

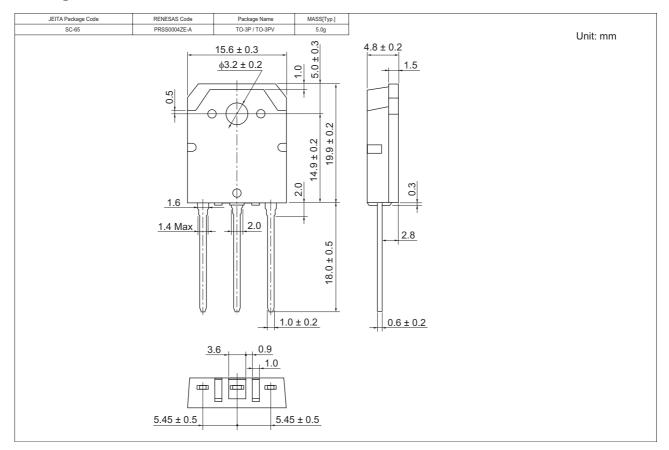
Electrical Characteristics

 $(Ta = 25^{\circ}C)$

Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to Source breakdown voltage	$V_{(BR)DSS}$	250	_	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Zero Gate voltage Drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 250 \text{ V}, V_{GS} = 0$
Gate to Source leak current	I _{GSS}	_	_	±0.1	μΑ	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Gate to Source cutoff voltage	$V_{GS(off)}$	3.0	_	4.5	V	$V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$
Forward transfer admittance	y _{fs}	29	49	_	S	$I_D = 35 \text{ A}, V_{DS} = 10 \text{ V}^{\text{Note4}}$
Static Drain to Source on state resistance	R _{DS(on)}	_	0.025	0.030	Ω	$I_D = 35 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	5500	_	pF	V _{DS} = 25 V
Output capacitance	Coss	_	820	_	рF	V _{GS} = 0 f = 1 MHz
Reverse transfer capacitance	Crss	_	115	_	рF	
Turn-on delay time	t _{d(on)}	_	70	_	ns	I _D = 35 A
Rise time	t _r	_	350	_	ns	$V_{GS} = 10 \text{ V}$ $R_L = 3.6 \Omega$ $Rg = 10 \Omega$
Turn-off delay time	t _{d(off)}	_	270	_	ns	
Fall time	t _f	_	230	_	ns	
Total Gate charge	Qg	_	155	_	nC	V _{DD} = 200 V
Gate to Source charge	Qgs	_	35	_	nC	$V_{GS} = 10 \text{ V}$ $I_D = 70 \text{ A}$
Gate to Drain charge	Qgd	_	75	_	nC	
Body-Drain diode forward voltage	V_{DF}		1.10	1.65	V	$I_F = 70 \text{ A}, V_{GS} = 0^{\text{Note4}}$
Body-Drain diode reverse recovery time	t _{rr}		220	_	ns	I _F = 70 A, V _{GS} = 0
Body-Drain diode reverse recovery charge	Qrr	_	1.8	_	μС	diF/dt = 100 A/μs

Notes: 4. Pulse test

Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
H5N2514P-E	30 pcs	Plastic magazine

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Renesas Technology Singapore Pte. Ltd.
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